

High-Current Density Surface Mount Schottky Rectifier



DO-214AB (SMC)

FEATURES

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- Very low forward voltage drop
- High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC


RoHS
COMPLIANT

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	5.0 A
V_{RRM}	30 V, 40 V
I_{FSM}	175 A
V_F	0.38 V, 0.42 V
T_J max.	150 °C

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

MECHANICAL DATA

Case: DO-214AB (SMC)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	SSC53L	SSC54	UNIT
Device marking code		53L	S54	
Maximum repetitive peak reverse voltage	V_{RRM}	30	40	V
Maximum RMS voltage	V_{RMS}	21	28	V
Maximum DC blocking voltage	V_{DC}	30	40	V
Maximum average forward rectified current at T_L (Fig. 1)	$I_{F(AV)}$	5.0		A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	175		A
Voltage rate of change (rated V_R)	dV/dt	10 000		V/ μ s
Operating junction temperature range	T_J	- 65 to + 150		°C
Storage temperature range	T_{STG}	- 65 to + 150		°C

ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	SSC53L		SSC54		UNIT
			TYP.	MAX.	TYP.	MAX.	
Maximum instantaneous forward voltage ⁽¹⁾	5.0 A $T_J = 25\text{ }^{\circ}\text{C}$ $T_J = 125\text{ }^{\circ}\text{C}$	V_F	0.42 0.33	0.45 0.38	0.45 0.36	0.49 0.42	V
Maximum reverse current at rated V_R ⁽²⁾	$T_J = 25\text{ }^{\circ}\text{C}$ $T_J = 125\text{ }^{\circ}\text{C}$	I_R	- 45	0.7 65	- 40	0.5 60	mA

Notes:(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: Pulse width $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	SSC53L	SSC54	UNIT
Typical thermal resistance ⁽¹⁾	$R_{\theta JA}$ $R_{\theta JL}$	60 20		$^{\circ}\text{C/W}$

Note:

(1) Aluminum substrate mounted

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SSC53L-E3/57T	0.235	57T	850	7" diameter plastic tape and reel
SSC53L-E3/9AT	0.235	9AT	3500	13" diameter plastic tape and reel
SSC53LHE3/57T ⁽¹⁾	0.235	57T	850	7" diameter plastic tape and reel
SSC53LHE3/9AT ⁽¹⁾	0.235	9AT	3500	13" diameter plastic tape and reel

Note:

(1) Automotive grade AEC Q101 qualified

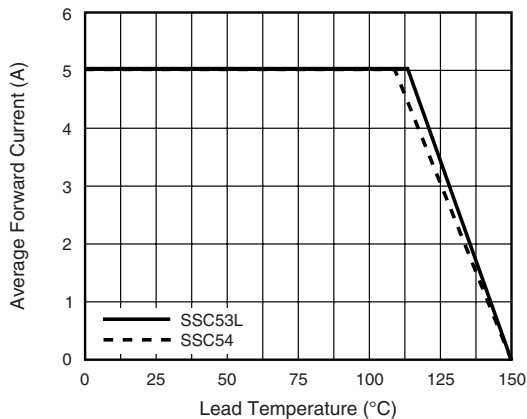
RATINGS AND CHARACTERISTICS CURVES($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

Figure 1. Forward Current Derating Curve

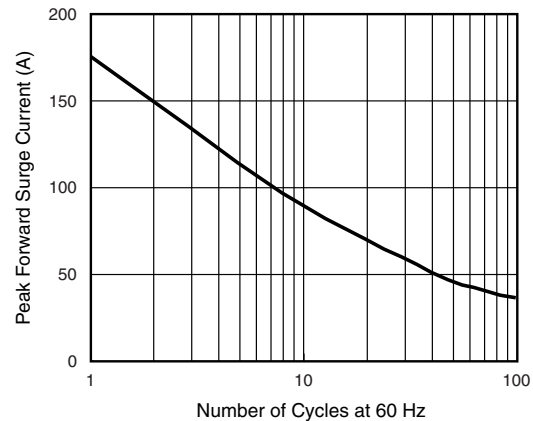


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

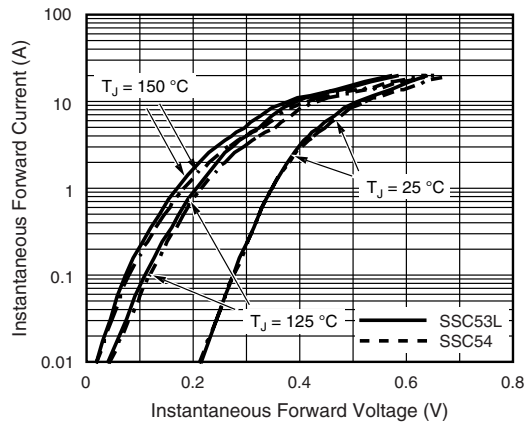


Figure 3. Typical Instantaneous Forward Characteristics

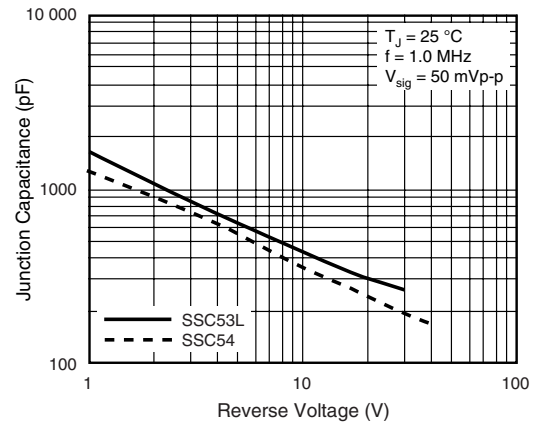


Figure 5. Typical Junction Capacitance

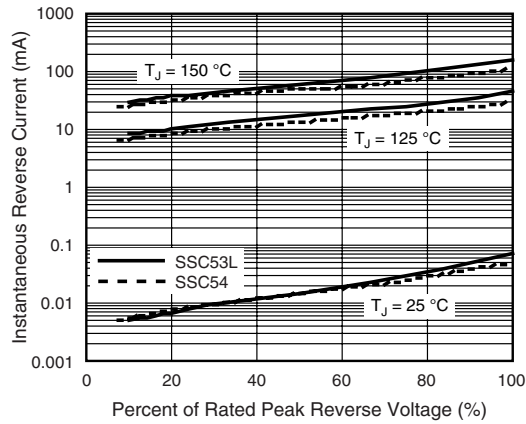
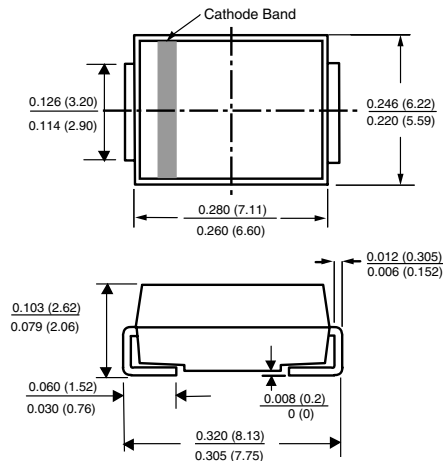


Figure 4. Typical Reverse Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AB (SMC)



Mounting Pad Layout

